

Customer Information Notification

Test Site Expansion from NXP-ATTJ

to KESM Tianjin, China

Issue Date:02-Nov-2018Effective Date:03-Nov-2018

Here's your personalized quality information concerning products Digi-Key purchased from NXP.

For detailed information we invite you to view this notification online

201809015I



QUALITY

Change Category		
[] Wafer Fab Process	[] Assembly [] Product Marking [X]	Test [] Design
	Process Loc	cation
[] Wafer Fab Materials	[] Assembly [] Mechanical []T	Fest []Errata
	Materials Specification Pro	ocess
[] Wafer Fab Location	[] Assembly [] []	Test [] Electrical
	Location Packing/Shipping/Labeling Equ	uipment spec./Test
		coverage
[] Firmware	[] Other	
i.MX6ULL and i.MX6UltraLite Final		

Description

NXP Semiconductors announces the Final Test site expansion for the i.MX6ULL and i.MX6UltraLite product associated with this notification, from the current NXP-ATTJ Tianjin, China Final Test site to the KESM Tianjin, China Final Test site.

Final Test site transfer was successfully qualified adhering to NXP specifications. **Reason** Qualification of KESM Tianjin, China is required for manufacturing flexibility and customer supply assurance. **Identification of Affected Products** Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality No impact on form, fit, function, reliability or quality. **Disposition of Old Products** NXP will reserve the right to ship from any location based on market demand situation.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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Affected Part Numbers
MCIMX6Y2DVM05AA
MCIMX6Y1CVM05AB
MCIMX6G3DVM05AA
MCIMX6G3DVM05AA
MCIMX6Y2CVM05AA
MCIMX6G2DVM05AA
MCIMX6G2DVM05AA
MCIMX6Y1CVM05AA
MCIMX6G2CVK05AA
MCIMX6Y7DVK05AA
MCIMX6G2DVK05AA
MCIMX6Y1CVK05AA
MCIMX6Y1DVK05AA
MCIMX6Y2CVM08AA
MCIMX6Y2DVM09AA
MCIMX6Y7DVM09AA
MCIMX6G1CVM05AB
MCIMX6G2CVM05AB
MCIMX6G2DVM05AB
MCIMX6G3CVM05AB
MCIMX6G3DVM05AB
MCIMX6G3DVM05AA